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FACSIMILE COVER SHEET

To Examiner: Alexander O. Williams	Total Pages Sent: 13
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Facsimile Number: (571) 273-8300	Transmission Date: November 10, 2005

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

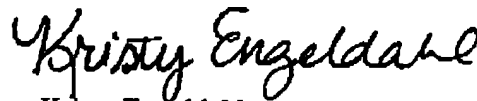
Applicant: Yu, *et al.* Docket No.: TSM03-0403
Serial No.: 10/684,224 Art Unit: 2826
Date Filed: October 10, 2003
TITLE: Copper Wiring With High Temperature Superconductor (HTS) Layer

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- Amendment (12 pages)

Respectfully submitted,



Kristy Engeldahl
Legal Assistant

Confirmation Respectfully Requested

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Filed: October 10, 2003 Examiner: Alexander O. Williams
For: Copper Wiring With High Temperature Superconductor (HTS) Layer

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT

Dear Sir:

The following amendments and remarks are presented in response to the Examiner's Office Action mailed August 10, 2005. Please amend the above-referenced application as follows.